

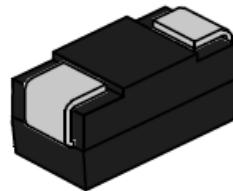


SM05KxxC Series Transient Voltage Suppressor

Rev.1.2

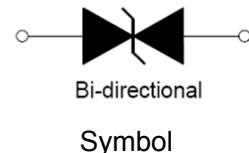
DESCRIPTION:

TVS diodes can be used in a wide range of applications which like consumer electronic products, automotive industries, munitions, telecommunications, aerospace industries, and intelligent control systems.



RoHS

SMB



Symbol

FEATURES:

- ◊ Low profile package.
- ◊ Low inductance.
- ◊ Excellent clamping capability.
- ◊ High peak pulse capability at 1.2/50 μ s-8/20 μ s@2Ω waveform.
- ◊ Typical I_R less than 1 μ A.
- ◊ Fast response time: typically less than 1.0ps from 0V to V_{BR} min.
- ◊ High temperature to reflow soldering: 260°C/40s at terminals.
- ◊ Plastic package has underwriters laboratory flammability 94V-0.
- ◊ Meets MSL level 1, per J-STD-020, LF maximum peak of 260°C.
- ◊ Terminal: solder plated, solderable per J-STD-002.
- ◊ For surface mounted applications in order to optimize board space.
- ◊ IEC61000-4-2 (ESD) ±30kV (air), ±30kV (contact).

ABSOLUTE MAXIMUM RATINGS($T_A=25^\circ\text{C}$, RH=45%-75%, unless otherwise noted)

| Parameter | Symbol | Value | Unit |
|---|-----------------|-------------|------|
| Operating junction and storage temperature range | T_J/T_{STG} | -55 to +150 | °C |
| Steady state power dissipation at $T_L=75^\circ\text{C}$ | $P_{M(AV)}$ | 5.0 | W |
| Peak pulse current at 1.2/50 μ s-8/20 μ s@2Ω waveform | I_{PP} | 500 | A |
| Typical thermal resistance junction to lead | $R_{\theta JL}$ | 20 | °C/W |
| Typical thermal resistance junction to ambient | $R_{\theta JA}$ | 100 | °C/W |

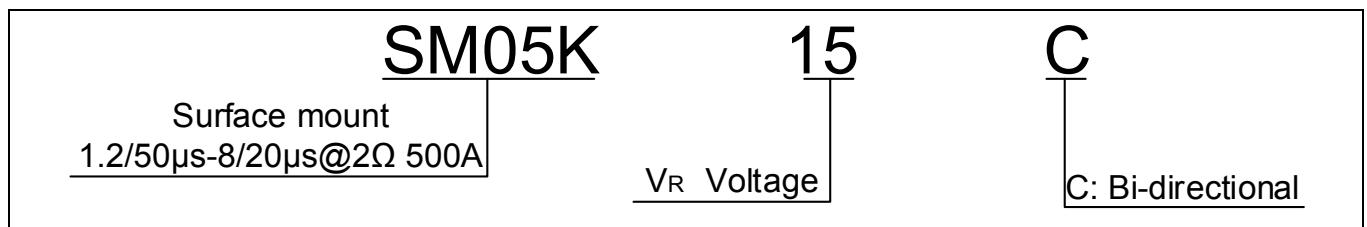
MARKING05K15C : Device Marking Code
2009: In ninth week, 2020**ELECTRICAL CHARACTERISTICS($T_A=25^\circ C$)**

| Part Number | Marking | V_R | $I_{R@V_R}$ | $V_{BR@I_T}$ | | I_T | $V_C@I_{PP}$ | $V_C@I_{PP}$ | $I_{PP}^{(1)}$ |
|-------------|---------|-------|-------------|--------------|--------|-------|--------------|--------------|----------------|
| Bi-polar | Bi | V | max(μA) | min(V) | max(V) | mA | typ(V) | max(V) | A |
| SM05K15C | 05K15C | 15 | 1 | 16.7 | 18.5 | 1 | 22 | 32 | 500 |
| ★SM05K18C | 05K18C | 18 | 1 | 20.0 | 22.3 | 1 | 25 | 37 | 500 |
| ★SM05K20C | 05K20C | 20 | 1 | 22.0 | 24.5 | 1 | 27 | 40 | 500 |
| ★SM05K30C | 05K30C | 30 | 1 | 33.3 | 38.0 | 1 | 39 | 48 | 500 |

(1) Surge waveform: 1.2/50μs-8/20μs@2Ω

 V_R : Stand-off voltage -- Maximum voltage that can be applied V_{BR} : Breakdown voltage V_C : Clamping voltage -- Peak voltage measured across the suppressor at a specified I_{PP} I_R : Reverse leakage current

★: Products with negative resistance

ORDERING INFORMATION

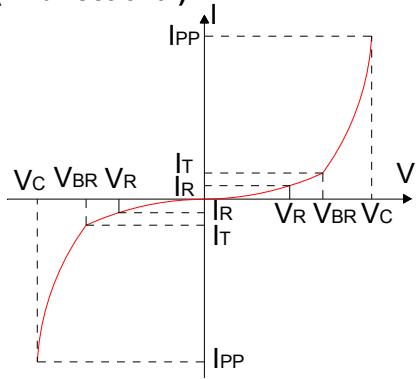
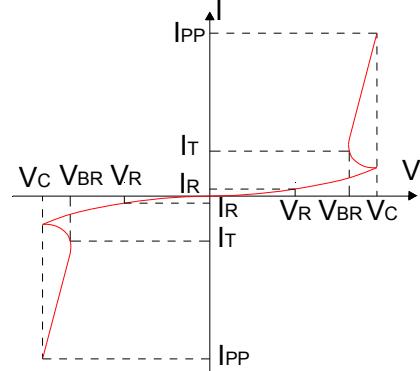
RATINGS AND V-I CHARACTERISTICS CURVES ($T_A=25^\circ\text{C}$, unless otherwise noted)FIG.1:V- I curve characteristics
(Bi-directional)FIG.2:V- I curve characteristics
(Bi-directional with negative resistance)

FIG.3: Pulse waveform

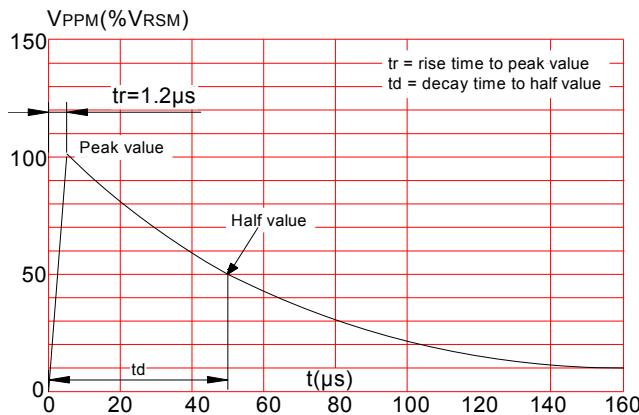


FIG.4: Pulse waveform

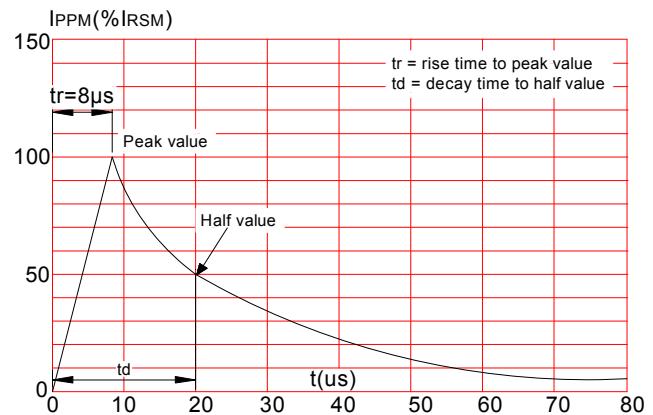
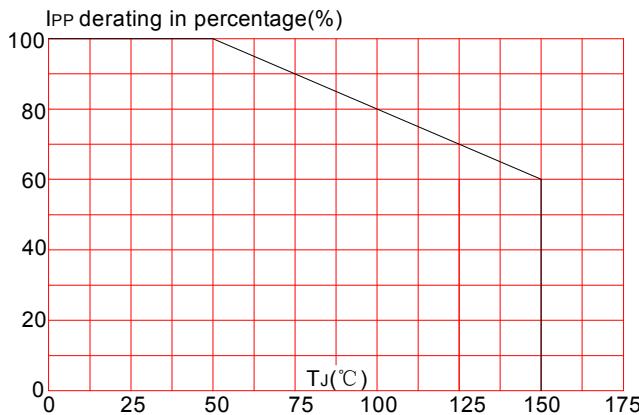
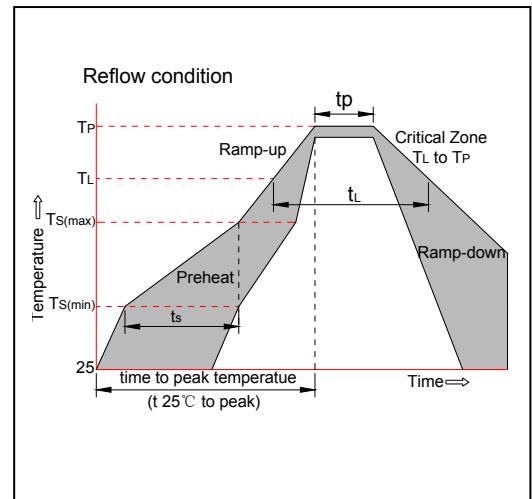


FIG.5: Pulse derating curve(8/20μs)

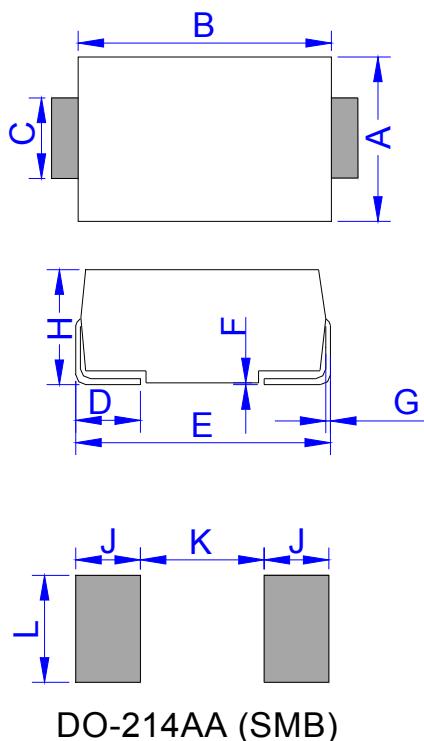


SOLDERING PARAMETERS

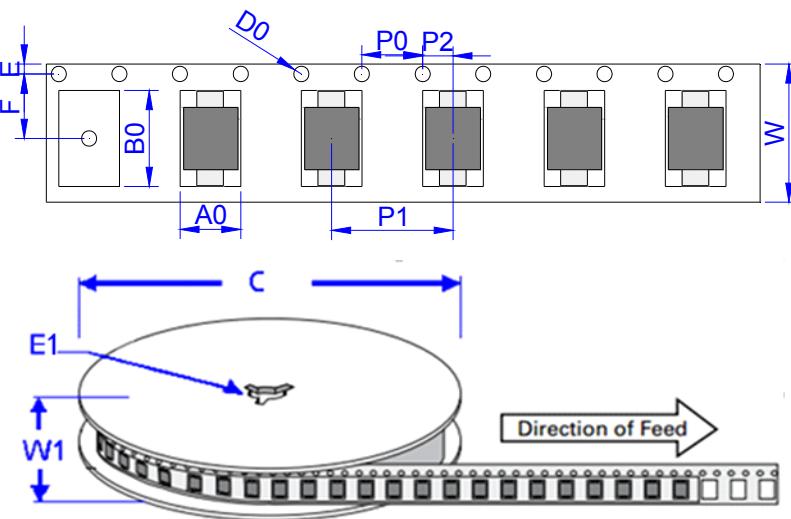
| | | |
|---|------------------------------------|---|
| Reflow Condition | | Pb-Free assembly (see figure at right) |
| Pre Heat | -Temperature Min ($T_{s(\min)}$) | +150°C |
| | -Temperature Max($T_{s(\max)}$) | +200°C |
| | -Time (Min to Max) (ts) | 60-180 secs. |
| Average ramp up rate (Liquidus Temp (T_L)to peak) | | 3°C/sec. Max |
| $T_{s(\max)}$ to T_L - Ramp-up Rate | | 3°C/sec. Max |
| Reflow | -Temperature(T_L)(Liquidus) | +217°C |
| | -Temperature(t_L) | 60-150 secs. |
| Peak Temp (T_p) | | +260(+0/-5)°C |
| Time within 5°C of actual Peak Temp (t_p) | | 20-40secs. |
| Ramp-down Rate | | 6°C/sec. Max |
| Time 25°C to Peak Temp (T_p) | | 8 min. Max |
| Do not exceed | | +260°C |



PACKAGE MECHANICAL DATA



| Ref. | Dimensions | | | |
|------|-------------|-------|--------|-------|
| | Millimeters | | Inches | |
| | Min. | Max. | Min. | Max. |
| A | 3.30 | 3.94 | 0.130 | 0.155 |
| B | 4.30 | 4.80 | 0.169 | 0.189 |
| C | 1.90 | 2.20 | 0.075 | 0.087 |
| D | 0.95 | 1.52 | 0.037 | 0.060 |
| E | 5.20 | 5.60 | 0.205 | 0.220 |
| F | 0.051 | 0.203 | 0.002 | 0.008 |
| G | 0.15 | 0.31 | 0.006 | 0.012 |
| H | 2.10 | 2.40 | 0.083 | 0.094 |
| J | 2.20 | | 0.087 | |
| K | | 2.60 | | 0.102 |
| L | 2.30 | | 0.091 | |

TAPE AND REEL SPECIFICATION-SMB


| Ref. | Dimensions | |
|------|-------------|----------------|
| | Millimeters | Inches |
| A0 | 3.76 ± 0.3 | 0.148 ± 0.012 |
| B0 | 5.69 ± 0.3 | 0.224 ± 0.012 |
| C | 330.0 | 13.0 |
| D0 | 1.55 ± 0.1 | 0.061 ± 0.004 |
| E | 1.75 ± 0.2 | 0.069 ± 0.008 |
| E1 | 13.3 ± 0.3 | 0.524 ± 0.012 |
| F | 5.5 ± 0.2 | 0.217 ± 0.008 |
| P0 | 4.00 ± 0.2 | 0.157 ± 0.008 |
| P1 | 8.00 ± 0.2 | 0.3145 ± 0.008 |
| P2 | 2.00 ± 0.2 | 0.079 ± 0.008 |
| W | 12.0 ± 0.2 | 0.472 ± 0.008 |
| W1 | 15.7 ± 2.0 | 0.618 ± 0.079 |

| PART No. | UNIT WEIGHT (g/PCS) typ. | REEL (PCS) | PER CARTON (PCS) | DESCRIPTION |
|----------|-----------------------------|---------------|---------------------|-------------------|
| SM05KxxC | 0.098 | 3,000 | 48,000 | 13 inch reel pack |

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